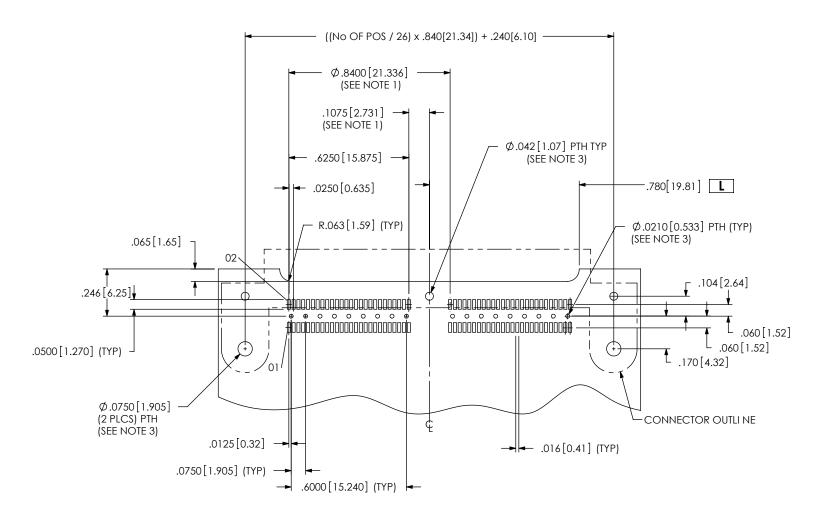
REVISION L

RECOMMENDED PCB LAYOUT FOR QMS-XXX-01-XX-D-RA

3/14/2013 ECN-199989

FIG 1 (QMS-052-01-XX-D-RA SHOWN)



ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE.

- 1. NOT REQUIRED FOR ONE BANK PART CONNECTOR.
- 2. DESIGNED IN ENGLISH.
- 3. TO BE SOLDERED USING PASTE IN HOLE TECHNOLOGY. 4. NOT RECOMMENDED FOR INVERTED REFLOW SOLDERING.

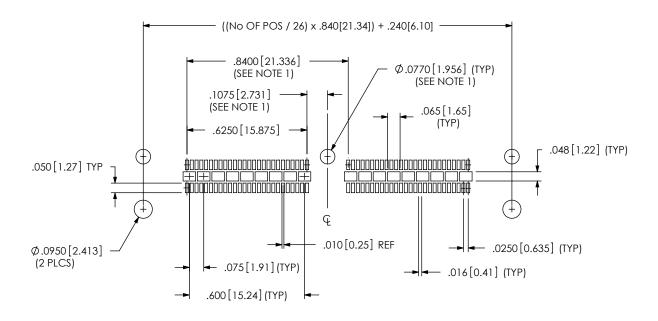
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NOTE: STENCIL TO BE .0060[.152] THICK.

FIG 2 (QMS-052-01-XX-D-RA SHOWN)



ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE.

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